

JUL 19 2005

ATTORNEY DOCKET NO. N1085-00260 [TSMC2003-0953]

Patent

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/781,217

Confirmation No.: 1933

In re application of: Chin Chen Kuo et al.

Filed: February 17, 2004

Technology Center/Art Unit: 2818

Examiner: Mai Huong C. Tran

AMENDMENT AFTER ALLOWANCE

Docket No.: N1085-00260

Customer No.: 08933

37 CFR § 1.312

Title: Image Sensor Fabrication Method  
And Structure

It's OK to enter  
08/15/05  
Mai Huong C. Tran

I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING  
TRANSMITTED TO THE U.S. PATENT AND TRADEMARK OFFICE,  
VIA FACSIMILE NO. (571) 273-8300ON: July 19, 2005  
Steven E. Koff  
Steven E. Koff, Reg No. 37,163

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Commissioner for Patents  
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Alexandria, VA 22313-1450

AMENDMENT AFTER ALLOWANCE, 37 CFR § 1.312

Sir:

In response to the Notice of Allowability dated May 2, 2005, please amend the above-identified application as follows:

Amendments to the Specification are reflected on page 2 of this paper.

Remarks/Arguments begin on page 3 of this paper.

PH111474642.1



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M. Koffler

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DOCKET NO.: N1085-00260 [TSMC2003-0953]

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Date of Notice  
of Allowance : 05/02/2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Chin Chen Kuo et al.

Group Art Unit: 2818

Serial No.: 10/781,217

Examiner: Mai Huong C. Tran

Filed: 02/17/2004

For: IMAGE SENSOR FABRICATION METHOD AND STRUCTURE

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ATTN: Official Draftsman

Sir:

TRANSMITTAL LETTER TO OFFICIAL DRAFTSMAN

Attached are formal drawings for Figs. 1A and 1B to replace the informal  
drawings filed with the above-captioned U.S. patent application. There have been no  
substantive changes made to these drawings.